



Hard disk for XP700

Part no. OS-HDU-A7-SI
Article no. 140377

Technical data

Power supply

Note on heat dissipation			not relevant
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Environmental conditions

Temperature			
Operating ambient temperature min.		°C	0
Operating ambient temperature max.		°C	+ 50

Design verification as per IEC/EN 61439

Technical data for design verification			
Operating ambient temperature min.		°C	0
Operating ambient temperature max.		°C	50
IEC/EN 61439 design verification			
10.2 Strength of materials and parts			
10.2.2 Corrosion resistance			Meets the product standard's requirements.
10.2.3.1 Verification of thermal stability of enclosures			Meets the product standard's requirements.
10.2.3.2 Verification of resistance of insulating materials to normal heat			Meets the product standard's requirements.
10.2.3.3 Verification of resistance of insulating materials to abnormal heat and fire due to internal electric effects			Meets the product standard's requirements.
10.2.4 Resistance to ultra-violet (UV) radiation			Meets the product standard's requirements.
10.2.5 Lifting			Does not apply, since the entire switchgear needs to be evaluated.
10.2.6 Mechanical impact			Does not apply, since the entire switchgear needs to be evaluated.
10.2.7 Inscriptions			Meets the product standard's requirements.
10.3 Degree of protection of ASSEMBLIES			Meets the product standard's requirements.
10.4 Clearances and creepage distances			Meets the product standard's requirements.
10.5 Protection against electric shock			Does not apply, since the entire switchgear needs to be evaluated.
10.6 Incorporation of switching devices and components			Does not apply, since the entire switchgear needs to be evaluated.
10.7 Internal electrical circuits and connections			Is the panel builder's responsibility.
10.8 Connections for external conductors			Is the panel builder's responsibility.
10.9 Insulation properties			
10.9.2 Power-frequency electric strength			Is the panel builder's responsibility.
10.9.3 Impulse withstand voltage			Is the panel builder's responsibility.
10.9.4 Testing of enclosures made of insulating material			Is the panel builder's responsibility.
10.10 Temperature rise			The panel builder is responsible for the temperature rise calculation. Eaton will provide heat dissipation data for the devices.
10.11 Short-circuit rating			Is the panel builder's responsibility.
10.12 Electromagnetic compatibility			Is the panel builder's responsibility.
10.13 Mechanical function			The device meets the requirements, provided the information in the instruction leaflet (IL) is observed.

Technical data ETIM 6.0

PLC's (EG000024) / PLC memory card (EC000192)			
Electric engineering, automation, process control engineering / Control / Programmable logic control (SPS) / SPS memory unit (ecl@ss8.1-27-24-22-12 [AKE535011])			
Type of memory			-
Memory size		kByte	80000000